

### 8.89mmx3.81mm LED LIGHT BAR

Part Number: KB-D100SRW

Super Bright Red

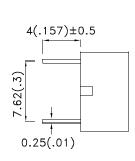
### **Features**

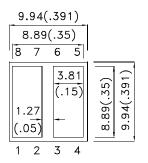
- Uniform light emitting area.
- Low current operation
- Easily mounted on P.C.boards.
- Flush mountable.
- Excellent on/off contrast.
- Can be used with panels and legend mounts.
- Categorized for luminous intensity.
- RoHS compliant.

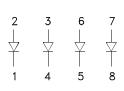
### Description

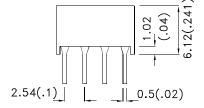
The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.

### **Package Dimensions& Internal Circuit Diagram**

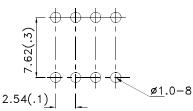








### RECOMMENDED PCB LAYOUT



## Pk



#### Notes

- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 SPEC NO: DSAA9424
 REV NO: V.12A
 DATE: JUN/03/2012
 PAGE: 1 OF 6

 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: F.Cui
 ERP: 1334000243

### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [1] @ 20mA	
		7,	Min.	Тур.
KB-D100SRW	Super Bright Red (GaAlAs)	White Diffused	55	120
		Willie Dillused	*12	*32

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.		Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Red	660	*655		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Red	640	*640		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Red	20			nm	IF=20mA
С	Capacitance	Super Bright Red	45			pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Red	1.8	15	2.5	V	IF=20mA
lr	Reverse Current	Super Bright Red			10	uA	V <sub>R</sub> =5V

### Absolute Maximum Ratings at TA=25°C

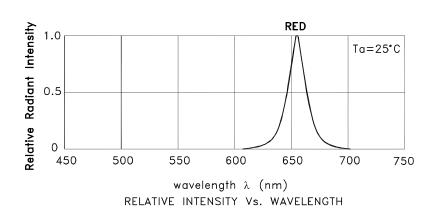
Parameter	Super Bright Red	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	155	mA		
Reverse Voltage	5	V		
Operating / Storage Temperature	-40°C To +85°C			
Lead Solder Temperature[2]	260°C For 3-5 Seconds			

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. 2mm below package base.

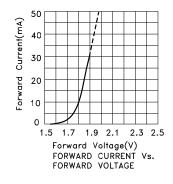
SPEC NO: DSAA9424 **REV NO: V.12A** DATE: JUN/03/2012 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED:** Joe Lee DRAWN: F.Cui ERP: 1334000243

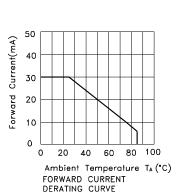
<sup>1.</sup> Luminous intensity/ luminous Flux: +/-15%.
\*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

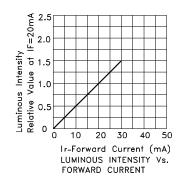
<sup>1.</sup>Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
\*Wavelength value is traceable to the CIE127-2007 compliant national standards.

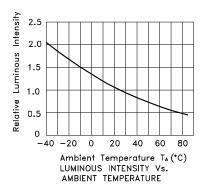


## Super Bright Red KB-D100SRW



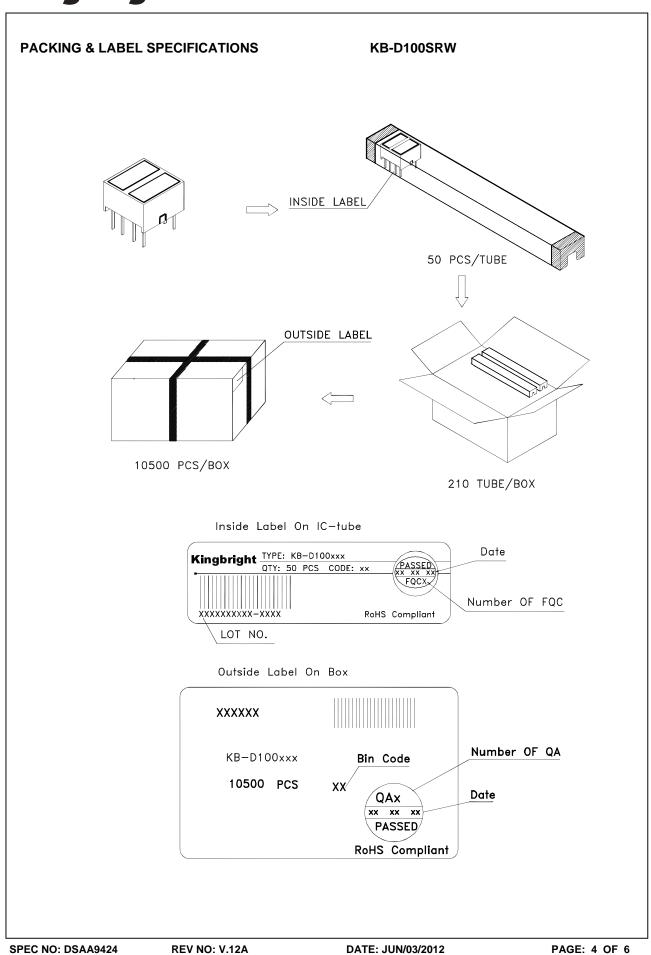






 SPEC NO: DSAA9424
 REV NO: V.12A
 DATE: JUN/03/2012
 PAGE: 3 OF 6

 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: F.Cui
 ERP: 1334000243



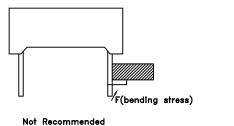
SPEC NO: DSAA9424 APPROVED: WYNEC REV NO: V.12A CHECKED: Joe Lee DATE: JUN/03/2012 DRAWN: F.Cui

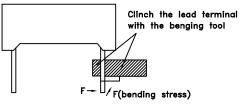
ERP: 1334000243

### THROUGH HOLE DISPLAY MOUNTING METHOD

### Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

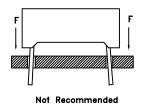


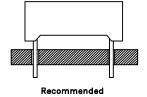


Recommended

### Installation

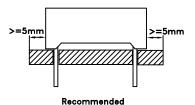
- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.





3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.

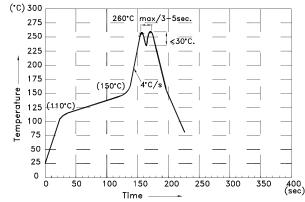




SPEC NO: DSAA9424 APPROVED: WYNEC REV NO: V.12A CHECKED: Joe Lee DATE: JUN/03/2012 DRAWN: F.Cui PAGE: 5 OF 6 ERP: 1334000243

### DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



#### NOTES:

- 1.Recommend the wave temperature 245°C $\sim$ 260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over  $85^{\circ}\text{C}$ .
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top-surface temperature should be kept below 105°C
- 5.No more than once.

### Soldering General Notes:

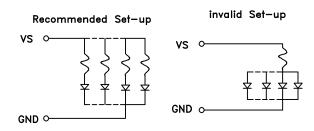
- 1. Through—hole displays are incompatible with reflow soldering.
- 2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

### **CLEANING**

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

### CIRCUIT DESIGN NOTES

- 1.Protective current—limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



 SPEC NO: DSAA9424
 REV NO: V.12A
 DATE: JUN/03/2012
 PAGE: 6 OF 6

 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: F.Cui
 ERP: 1334000243